

650V N-Channel MOSFET

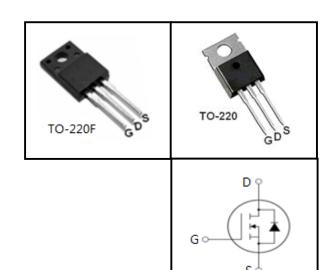
FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device Marking and Package Information				
Device	Package	Marking		
CS8N65F	TO-220F	CS8N65F		
CS8N65P	TO-220	CS8N65P		



Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted					
Parameter	Symbol	Va	l lmit		
Parameter		TO-220F	TO-220	Unit	
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}	650		V	
Continuous Drain Current	I _D	8		А	
Pulsed Drain Current (note1)	I _{DM}	32		А	
Gate-Source Voltage	V _{GSS}	±30		V	
Single Pulse Avalanche Energy (note2)	E _{AS}	245		mJ	
Avalanche Current (note1)	I _{AS}	7		Α	
Repetitive Avalanche Energy (note1)	E _{AR}	147		mJ	
Power Dissipation (T _C = 25°C)	P _D	64	107	W	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150		°C	

Thermal Resistance				
Personator	Symbol	Val	l lmit	
Parameter		TO-220F	TO-220	Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	1.95	1.17	IZ/\A/
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60	K/W



Specifications $T_J = 25^{\circ}$ C, unless otherwise noted								
Parameter	Symbol	Tank Canadistana	Value			11		
	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	650			>		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μΑ		
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA		
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		4.0	V		
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 4A		0.95	1.15	Ω		
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$ $f = 1.0MHz$		1110		pF		
Output Capacitance	C _{oss}			106				
Reverse Transfer Capacitance	C _{rss}			13				
Total Gate Charge	Q_g	$V_{DD} = 520V, I_D = 8A,$ $V_{GS} = 10V$		37		nC		
Gate-Source Charge	Q_{gs}			5				
Gate-Drain Charge	Q_{gd}	65 -		24				
Turn-on Delay Time	t _{d(on)}	$V_{DD} = 325V, I_{D} = 8A,$ $R_{G} = 25 \Omega$		39		ns		
Turn-on Rise Time	t _r			10				
Turn-off Delay Time	t _{d(off)}			152				
Turn-off Fall Time	t _f			42				
Drain-Source Body Diode Character	istics							
Continuous Body Diode Current	Is	T			8	A		
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			32			
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}C$, $I_{SD} = 4A$, $V_{GS} = 0V$			1.4	V		
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V, I_{S} = 8A,$ $di_{F}/dt = 100A / \mu s$		601		ns		
Reverse Recovery Charge	Q _{rr}			2.3		μC		

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}C$
- 3. Pulse Test: Pulse width ≤ 325µs, Duty Cycle ≤ 1%



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 1. Output Characteristics (T_J = 25°C)

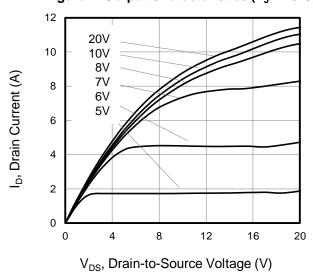


Figure 3. Drain Current vs. Temperature

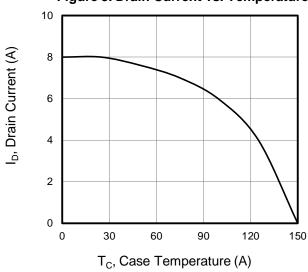


Figure 5. Transfer Characteristics

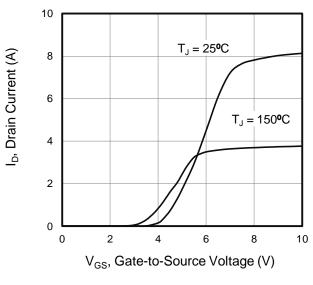
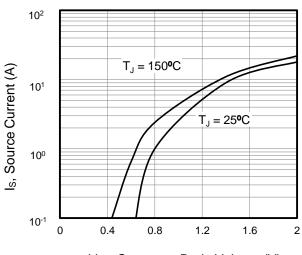
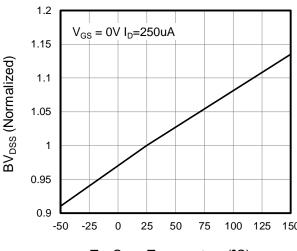


Figure 2. Body Diode Forward Voltage



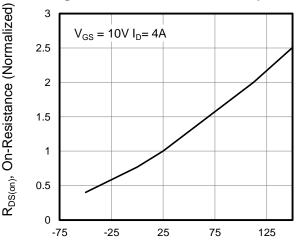
V_{SD}, Source-to-Drain Voltage (V)

Figure 4. BV_{DSS} Variation vs. Temperature



T_C, Case Temperature (°C)

Figure 6. On-Resistance vs. Temperature



 T_J , Junction Temperature (${}^{\circ}C$)



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

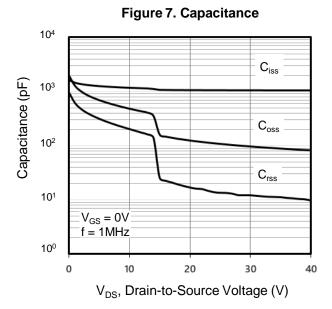


Figure 9. Transient Thermal Impedance

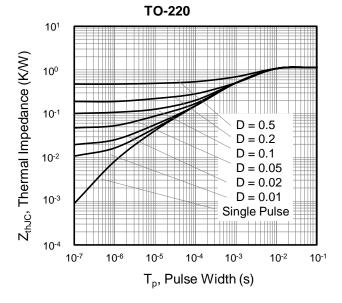


Figure 8. Gate Charge

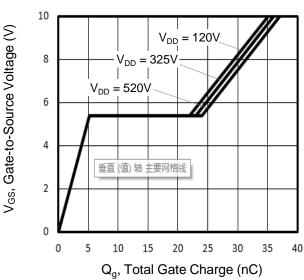


Figure 10. Transient Thermal Impedance

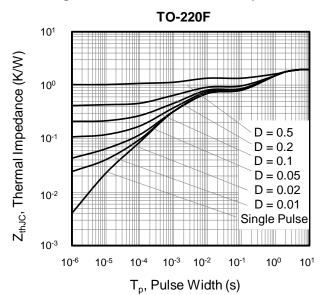




Figure A: Gate Charge Test Circuit and Waveform

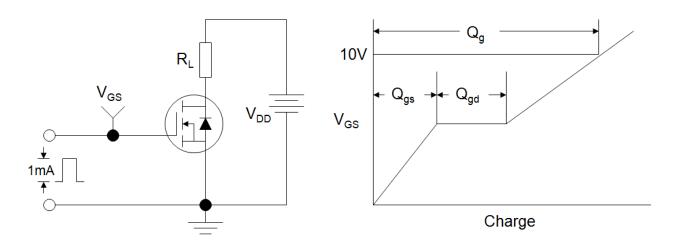


Figure B: Resistive Switching Test Circuit and Waveform

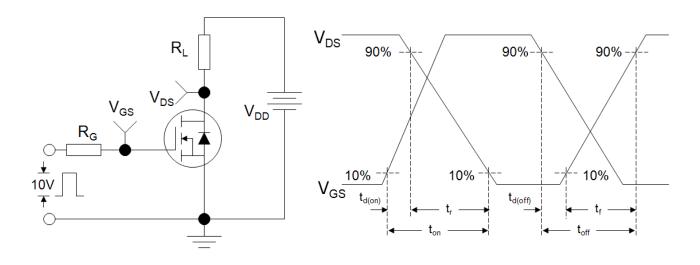
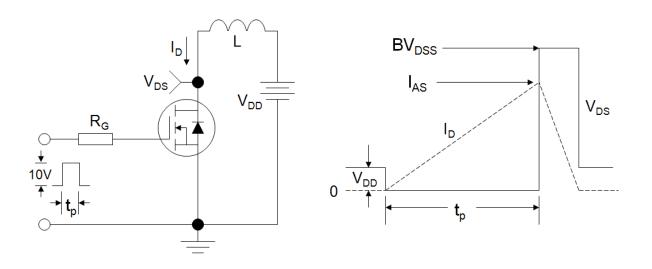
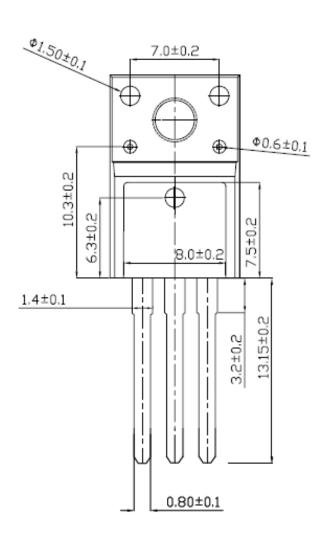


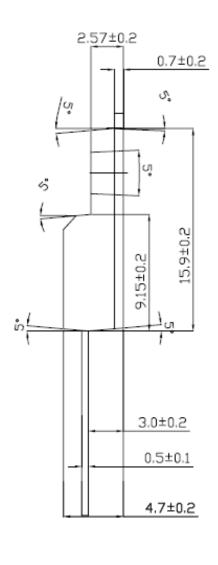
Figure C: Unclamped Inductive Switching Test Circuit and Waveform





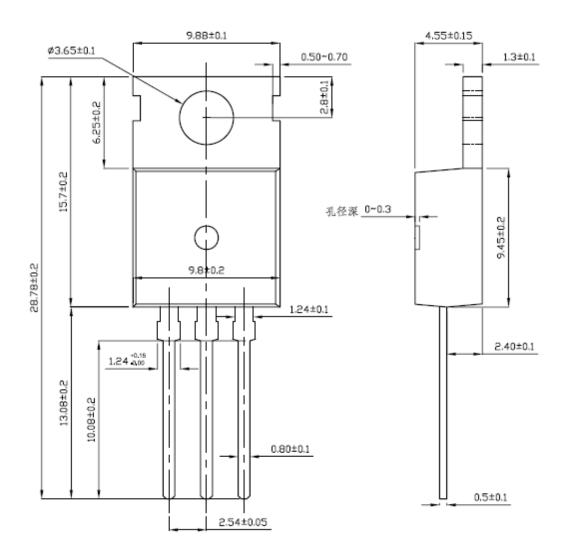
TO-220F







TO-220





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